

EL TOP VIEW LED 67-63-RGB0200H-A04-2T-AM



Features

- Package : PLCC 6 package
- Color : Red , Green, and Blue
- Typ. Luminance Intensity : Red 710 mcd, Green 1400 mcd, Blue 280 mcd @20mA
- Viewing angle : 120°
- ESD : Red-2kV, Green/Blue-8kV
- MSL : 2
- Qualified AEC-Q101
- The product itself will remain within RoHS compliant version
- Compliance with EU REACH
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)

Applications

- Automotive interior lighting.
- Ambient light.
- Switches.

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1. Characteristics

Parameter		Symbol	Min.	Typ.	Max.	Unit	Condition
Forward Current	Red	I_F	5	20	50	mA	---
	Green		3	20	30		
	Blue		3	20	30		
Luminous Intensity	Red	I_v	560	710	1400	mcd	$I_F=20mA$
	Green		1120	1400	2240		
	Blue		224	280	450		
Forward Voltage	Red	V_F	1.75	1.95	2.75	V	$I_F=20mA$
	Green		2.5	3.10	3.75		
	Blue		2.5	3.00	3.75		
Viewing Angle	Red	ϕ	---	116	---	deg	$I_F=20mA$
	Green		---	126	---		
	Blue		---	104	---		
Dominant Wavelength	Red	λ_d	619	623	633	nm	$I_F=20mA$
	Green		520	527	535		
	Blue		447	451	459		
Thermal Resistance (Junction to Solder)	Real	Red	---	---	160	K/W	$I_F=20mA$
		Green	---	---	130		
		Blue	---	---	130		
	Electrical	Red	---	---	125		
		Green	---	---	100		
		Blue	---	---	100		

Notes:

1. Luminous Flux measurement tolerance: $\pm 8\%$.
2. The data of Luminous Flux measured at thermal pad=25°C
3. Forward voltage measurement tolerance: $\pm 0.05V$
4. The V_F range shown in the table above indicates 99% output.
5. Tolerance of Dominant Wavelength : $\pm 1nm$.

2. Absolute Maximum Ratings

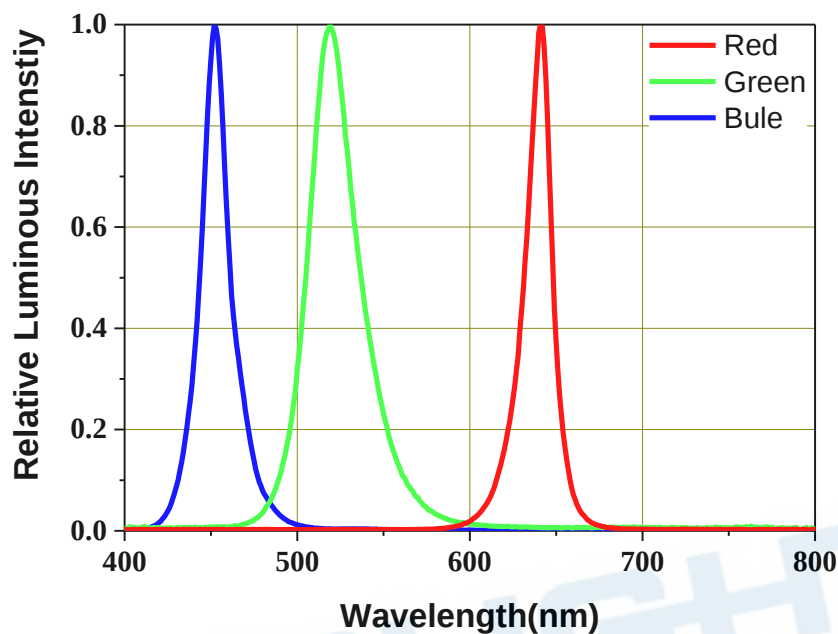
Parameter	Symbol	Ratings			Unit
		Red	Green	Bule	
Power Dissipation	P_d	137	112	112	mW
Forward Current	I_F	50	30	30	mA
Surge Current ($t \leq 10 \mu s$; $D=0.005$; $T_s=25^\circ C$)	I_{FM}	300	250	250	mA
Reverse Voltage	V_R	Not designed for reverse operation			V
Junction Temperature	T_J	125			$^\circ C$
Operating Temperature	T_{opr}	-40 ~ +110			$^\circ C$
Storage Temperature	T_{stg}	-40 ~ +110			$^\circ C$
ESD Sensitivity ($R=1.5k\Omega$, $C=100pF$)	ESD_{HBM}	2	8	8	kV
Soldering Temperature	Reflow	260 $^\circ C$ for 30sec			$^\circ C$

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3. Characteristics Graph

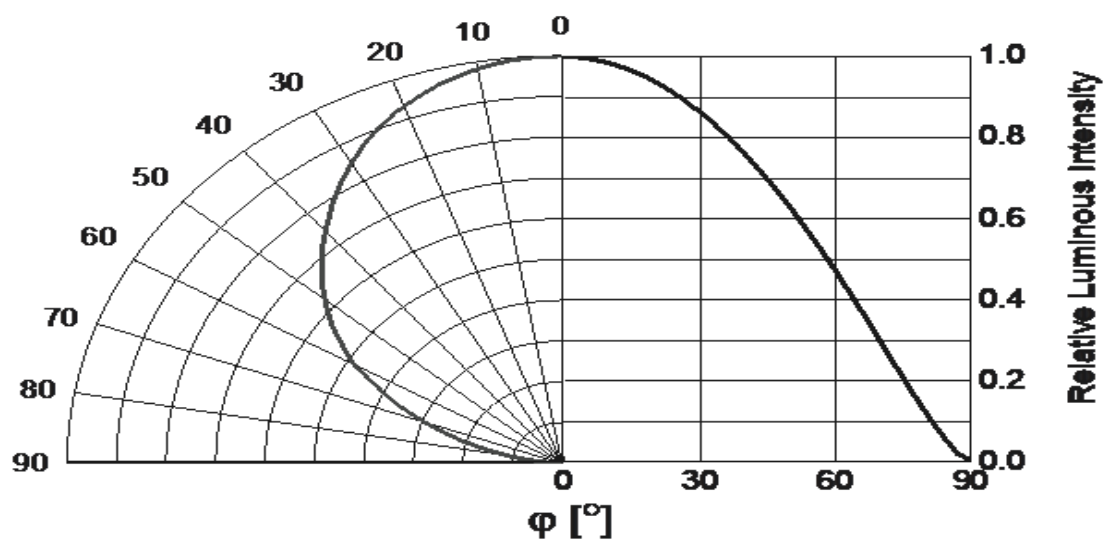
Wavelength Characteristics Relative Spectral Distribution
 @ Ts = 25°C, I_F=20mA

$$\Phi_V / \Phi_V (Max.) = f(\lambda)$$



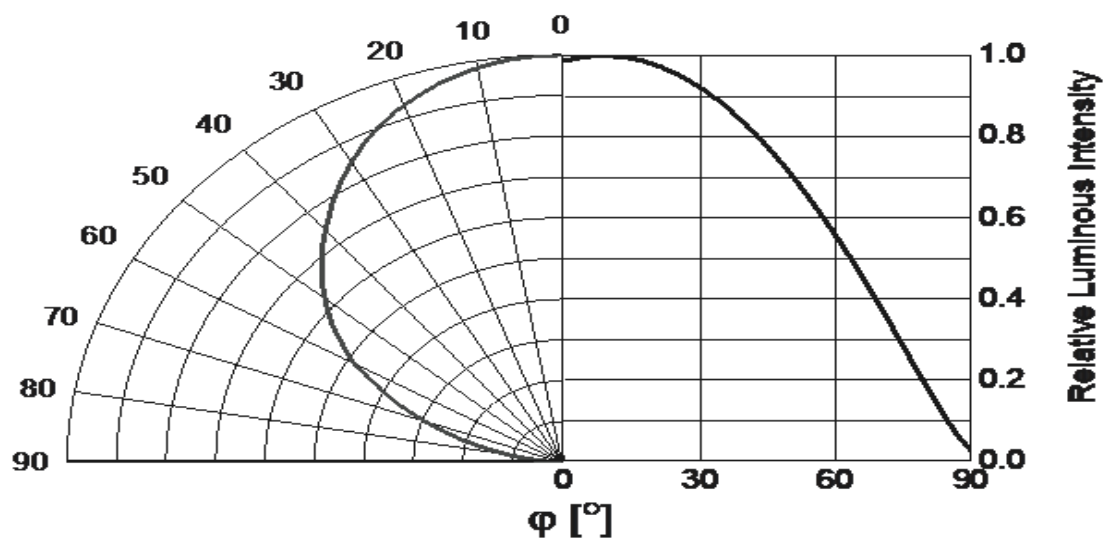
Typical Diagram Characteristics of Radiation (Red)

$$\Phi_V / \Phi_V (0^\circ) = f(\varphi)$$



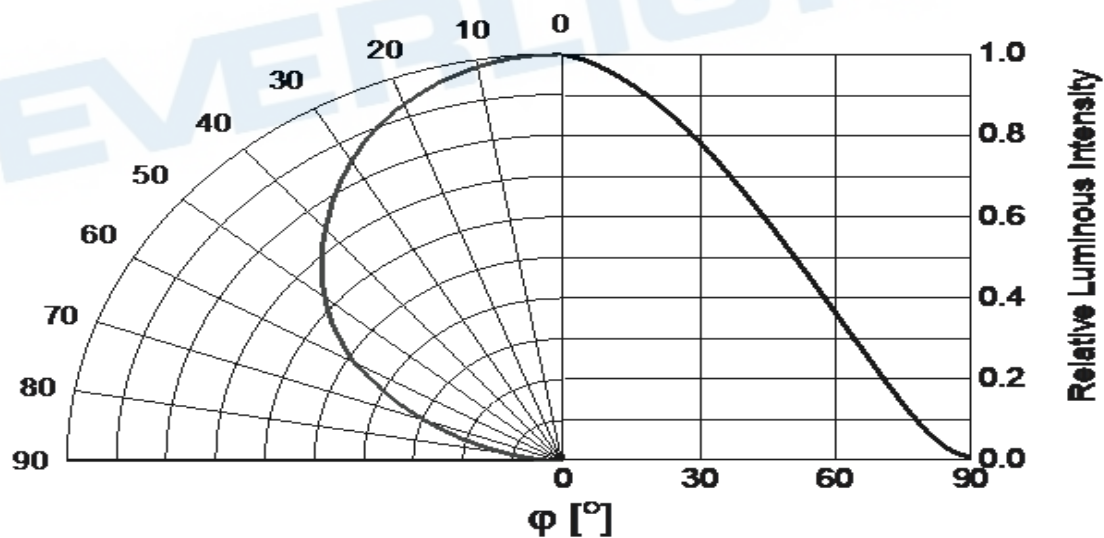
Typical Diagram Characteristics of Radiation (Green)

$$\Phi_V / \Phi_V(0^\circ) = f(\varphi)$$



Typical Diagram Characteristics of Radiation (Blue)

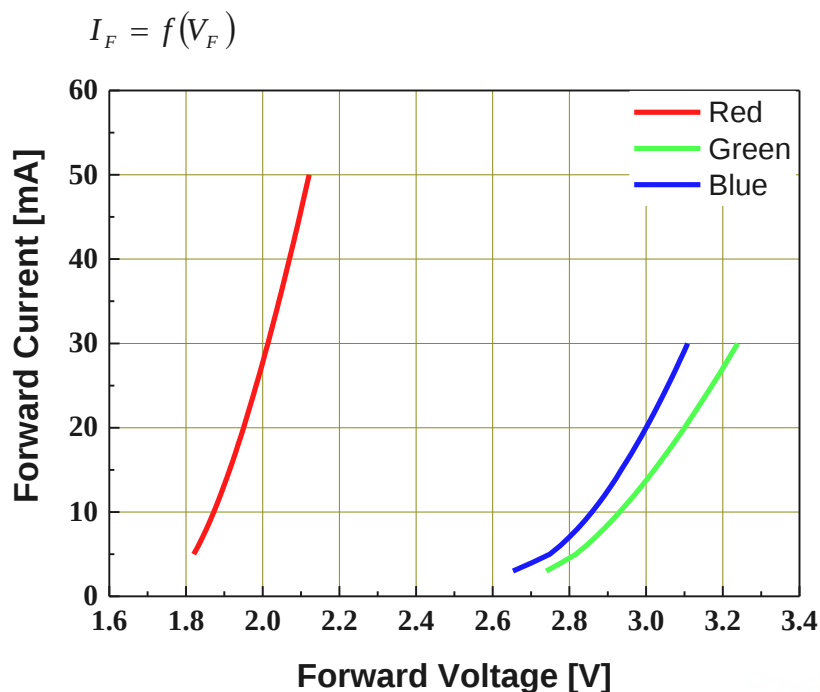
$$\Phi_V / \Phi_V(0^\circ) = f(\varphi)$$



Notes:

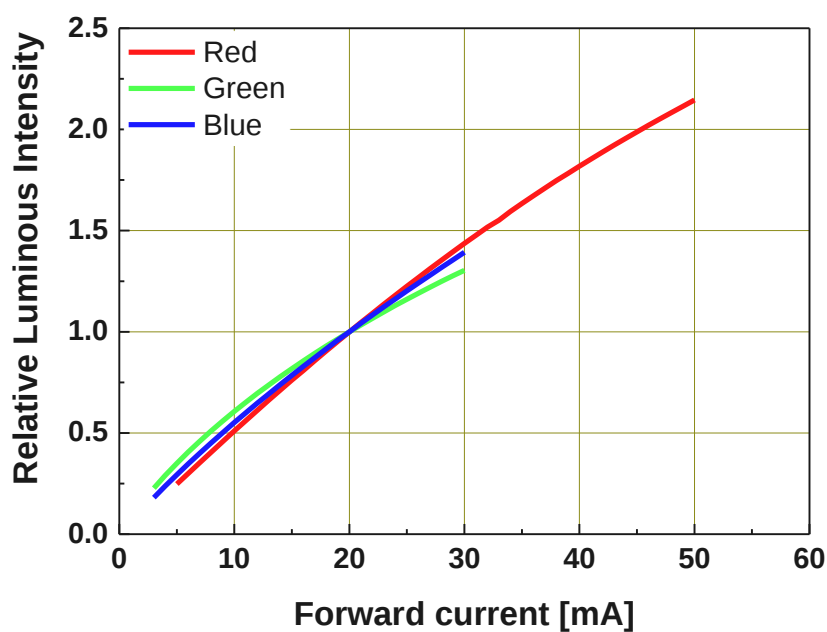
1. φ is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.
2. View angle tolerance is $\pm 5^\circ$.

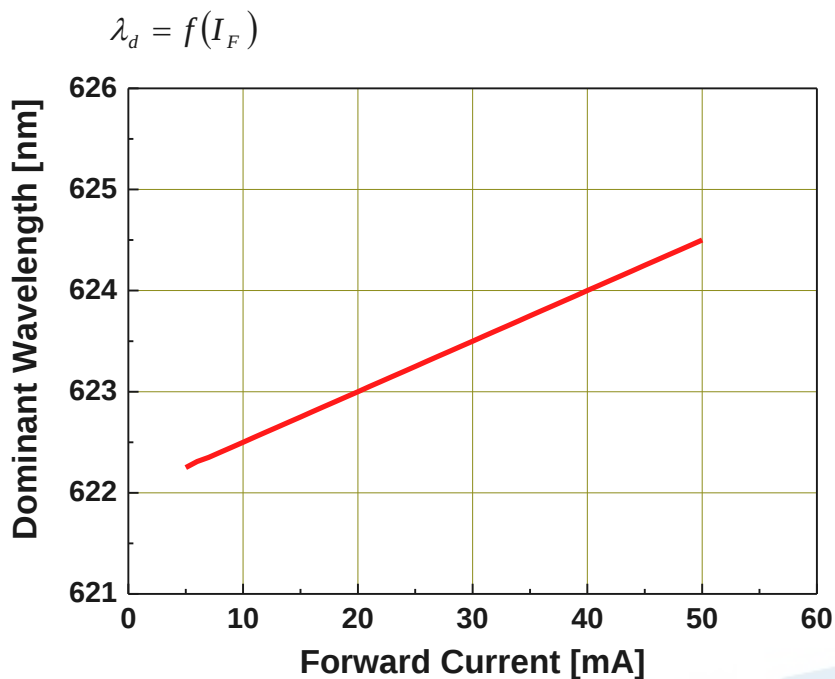
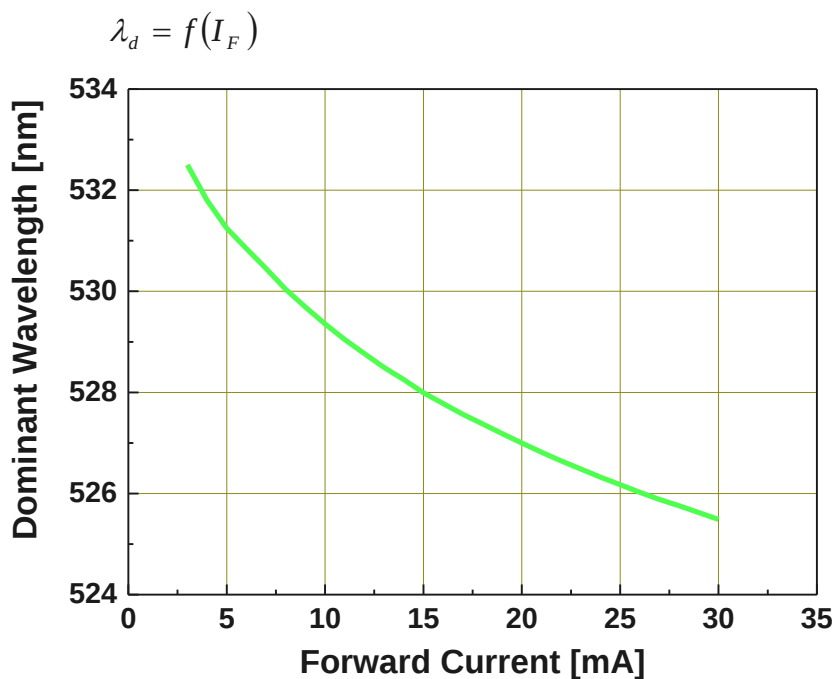
Forward Current vs. Forward Voltage @ Ts = 25°C



Relative Luminous Intensity vs. Forward Current @ Ts = 25°C

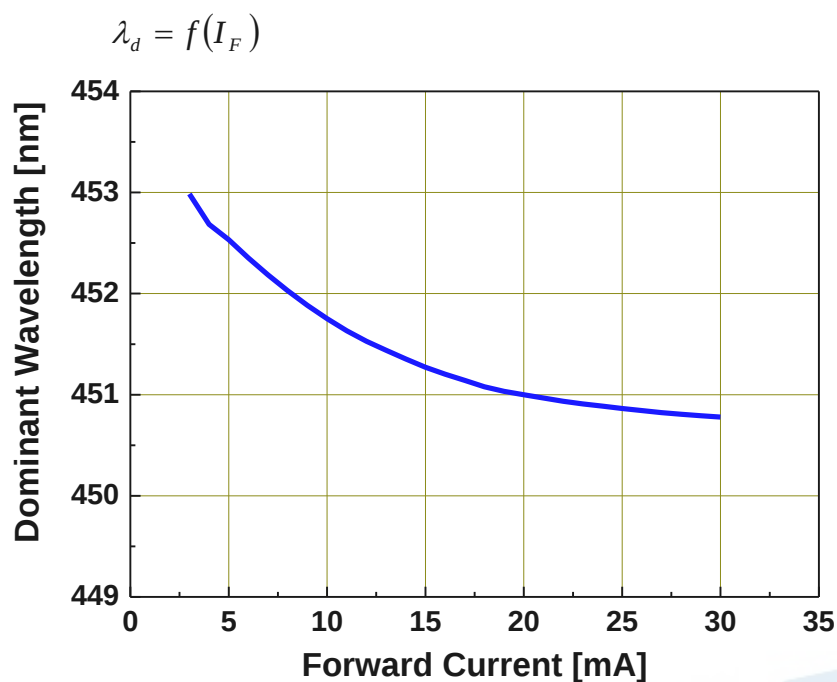
$$\Phi_V / \Phi_V(20mA) = f(I_F)$$



Dominant Wavelength vs. Forward Current (Red)**@ Ts = 25°C****Dominant Wavelength vs. Forward Current (Green)****@ Ts = 25°C**

Dominant Wavelength vs. Forward Current (Blue)

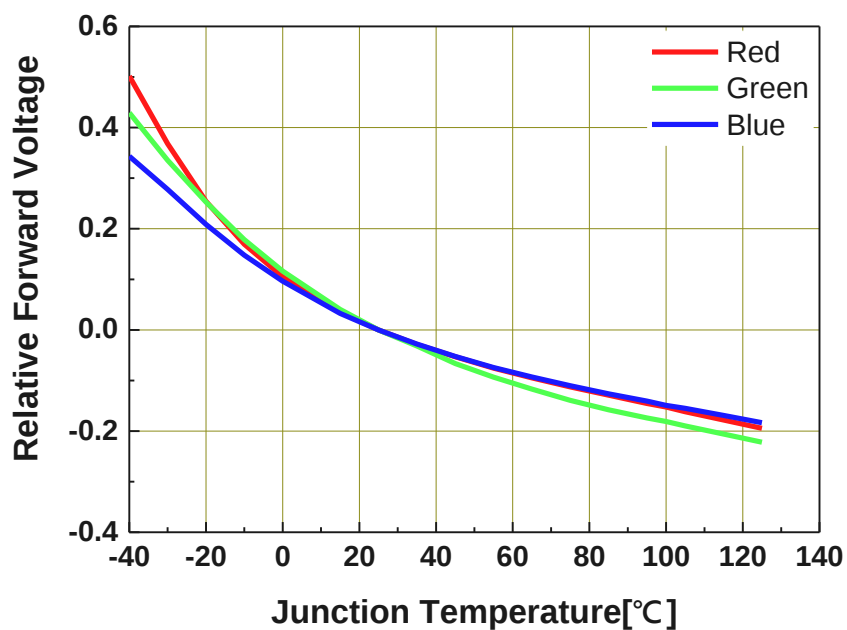
@ $T_s = 25^\circ\text{C}$



Relative Forward Voltage vs. Junction Temperature

@ $I_F = 20\text{mA}$

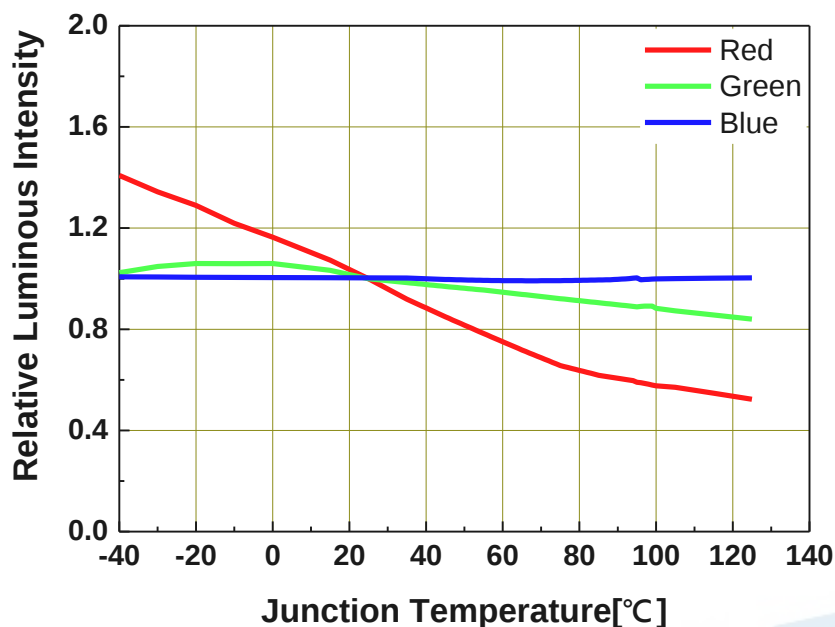
$$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j)$$



Relative Luminous Intensity vs. Junction Temperature

@ $I_F=20\text{mA}$

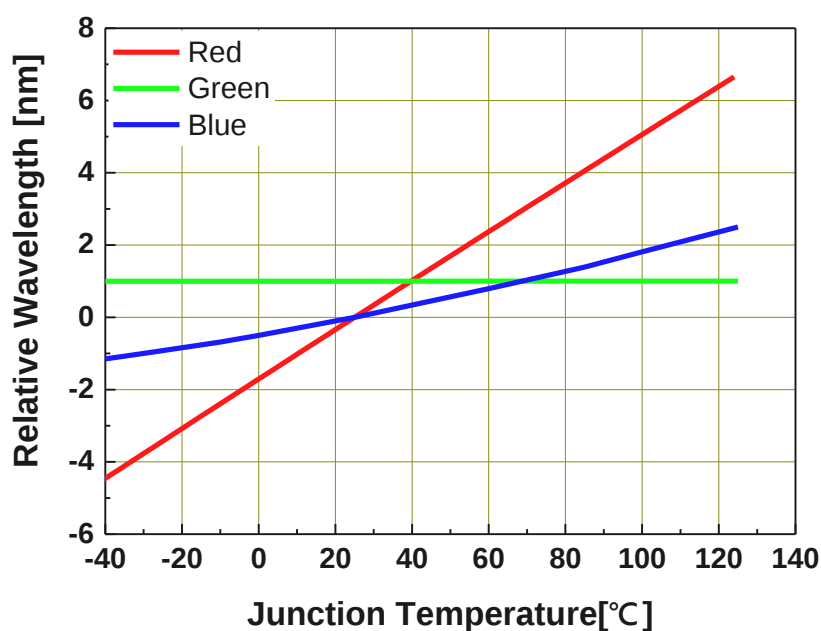
$$\Phi_V / \Phi_V(25^\circ\text{C}) = f(T_j)$$



Relative Wavelength Shift vs. Junction Temperature

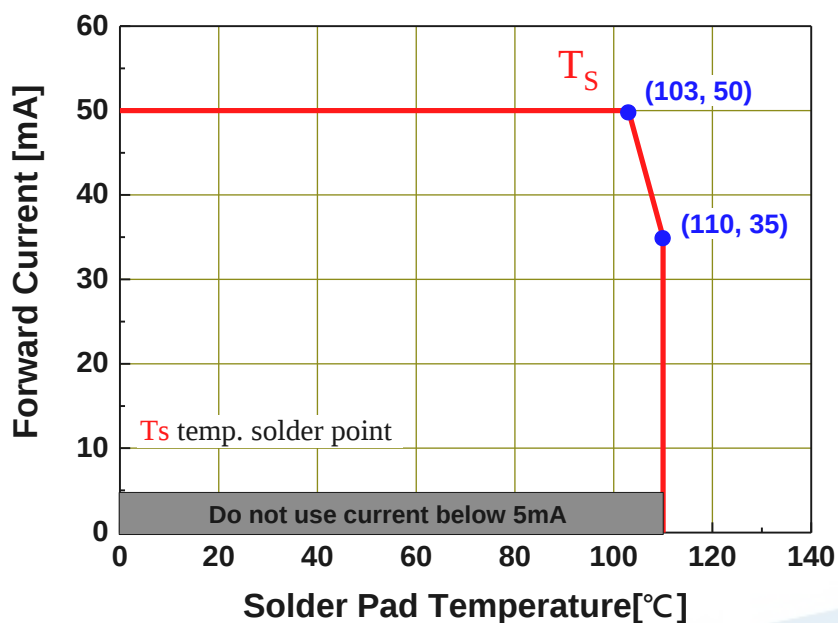
@ $I_F=20\text{mA}$

$$\Delta\lambda_d = \lambda_d - \lambda_d(25^\circ\text{C}) = f(T_j)$$



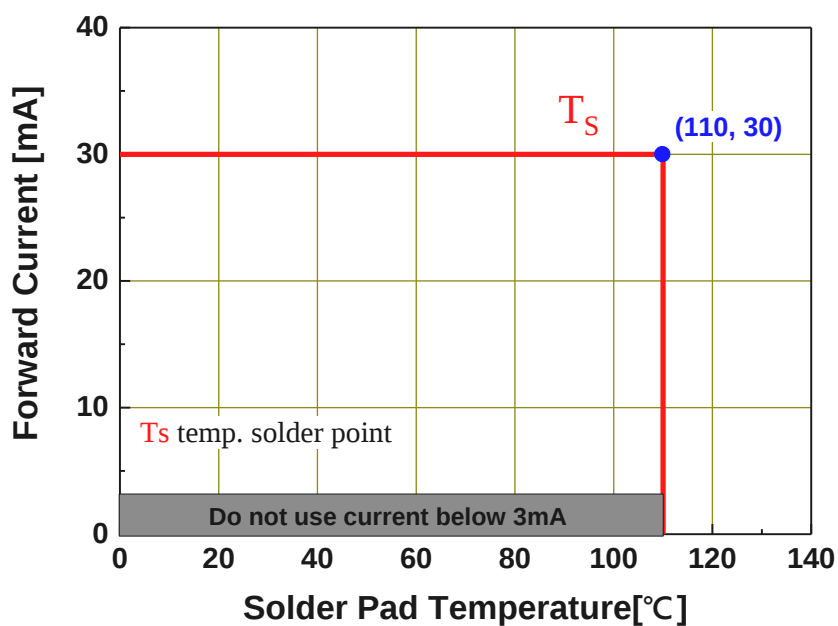
Forward Current Derating Curve (Red)

$$I_F = f(T_S)$$



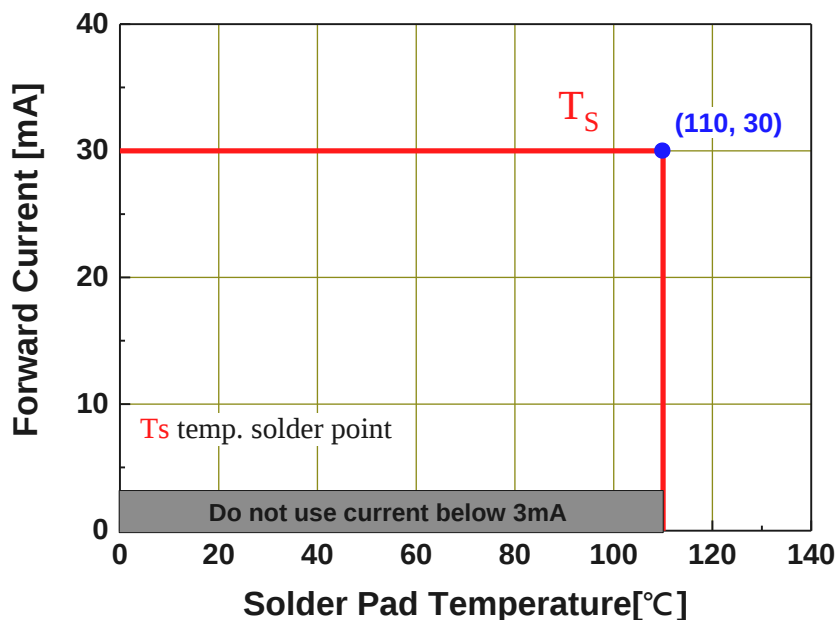
Forward Current Derating Curve (Green)

$$I_F = f(T_S)$$



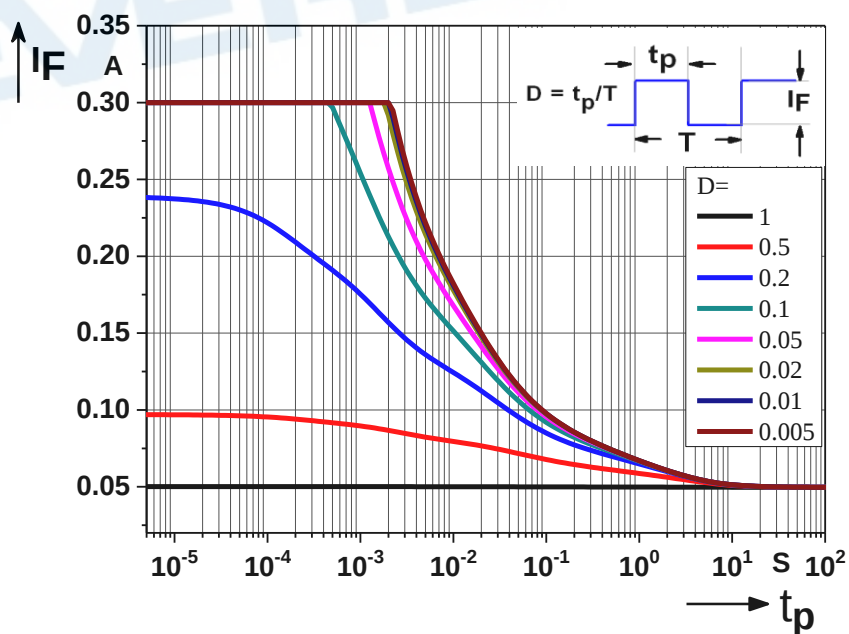
Forward Current Derating Curve (Blue)

$$I_F = f(T_S)$$



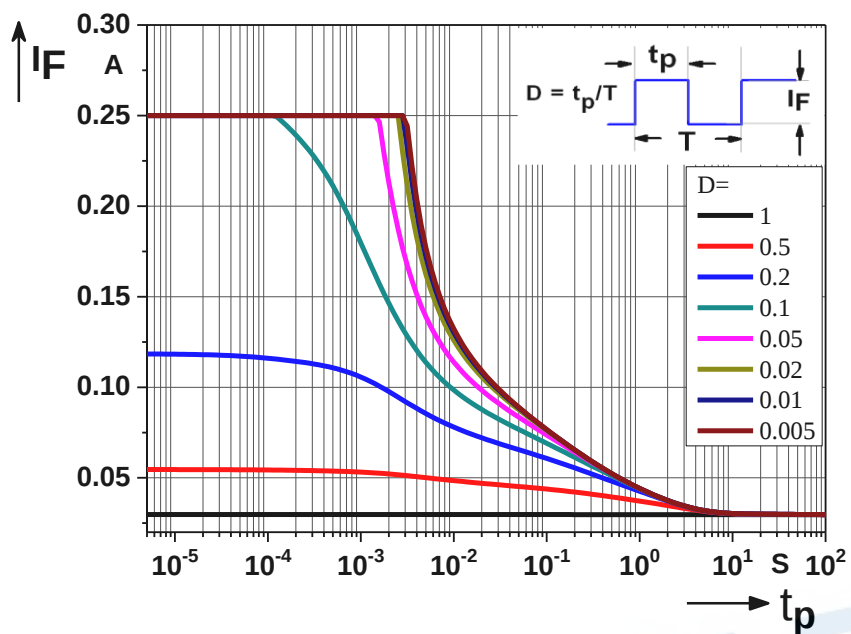
Permissible Pulse Handling Capability (Red)

D=Duty cycle, $T_S = 25^\circ\text{C}$



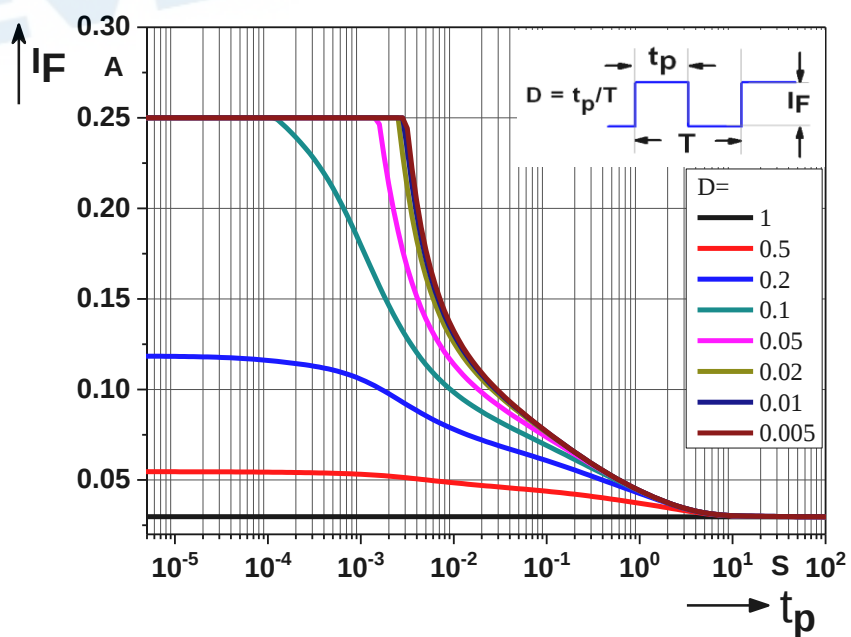
Permissible Pulse Handling Capability (Green)

D =Duty cycle , $T_s = 25^\circ\text{C}$



Permissible Pulse Handling Capability (Blue)

D =Duty cycle , $T_s = 25^\circ\text{C}$



4. Binning Information

Luminous Intensity Bins

Group Bin	Minimum Luminous Intensity (mcd)	Maximum Luminous Intensity (mcd)
L1	11.2	14
L2	14	18
M1	18	22.4
M2	22.4	28
N1	28	35.5
N2	35.5	45
P1	45	56
P2	56	71
Q1	71	90
Q2	90	112
R1	112	140
R2	140	180
S1	180	224
S2	224	280
T1	280	355
T2	355	450
U1	450	560
U2	560	710
V1	710	900
V2	900	1120
AA	1120	1400
AB	1400	1800
BA	1800	2240
BB	2240	2800
CA	2800	3550
CB	3550	4500
DA	4500	5600
DB	5600	7100
EA	7100	9000
EB	9000	11200
FA	11200	14000
FB	14000	18000
GA	18000	22400

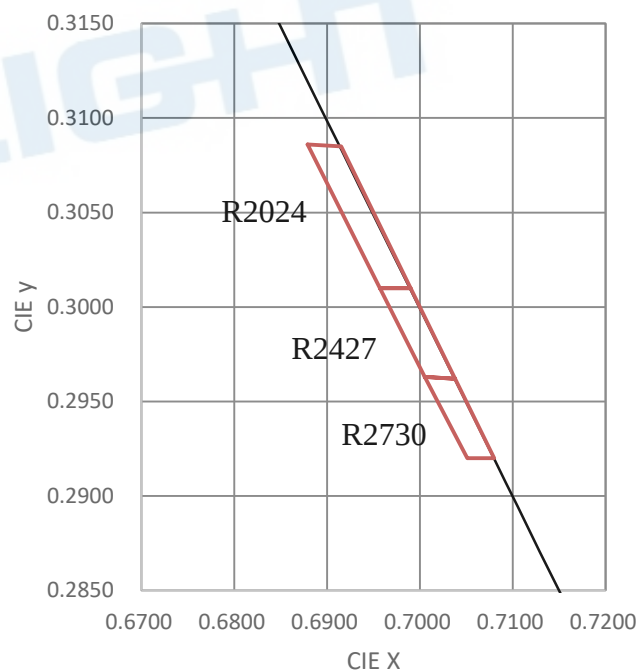
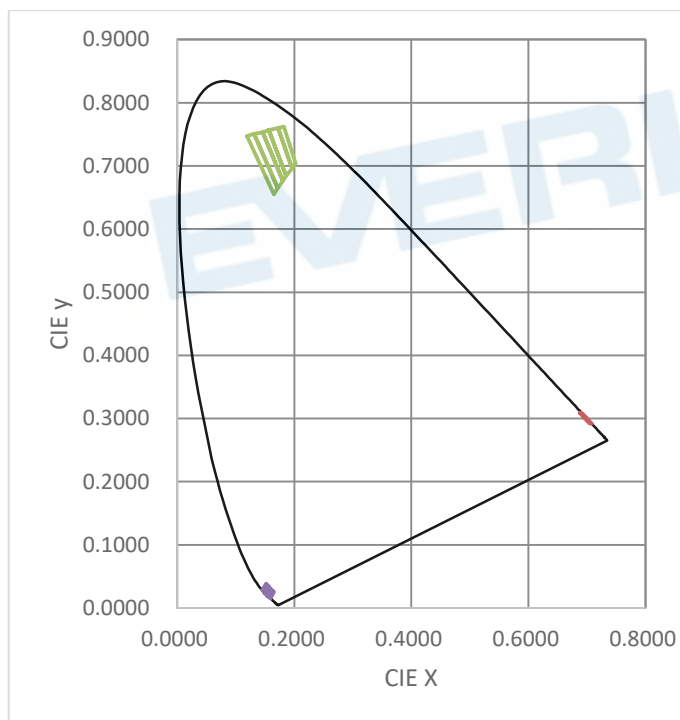
Notes:

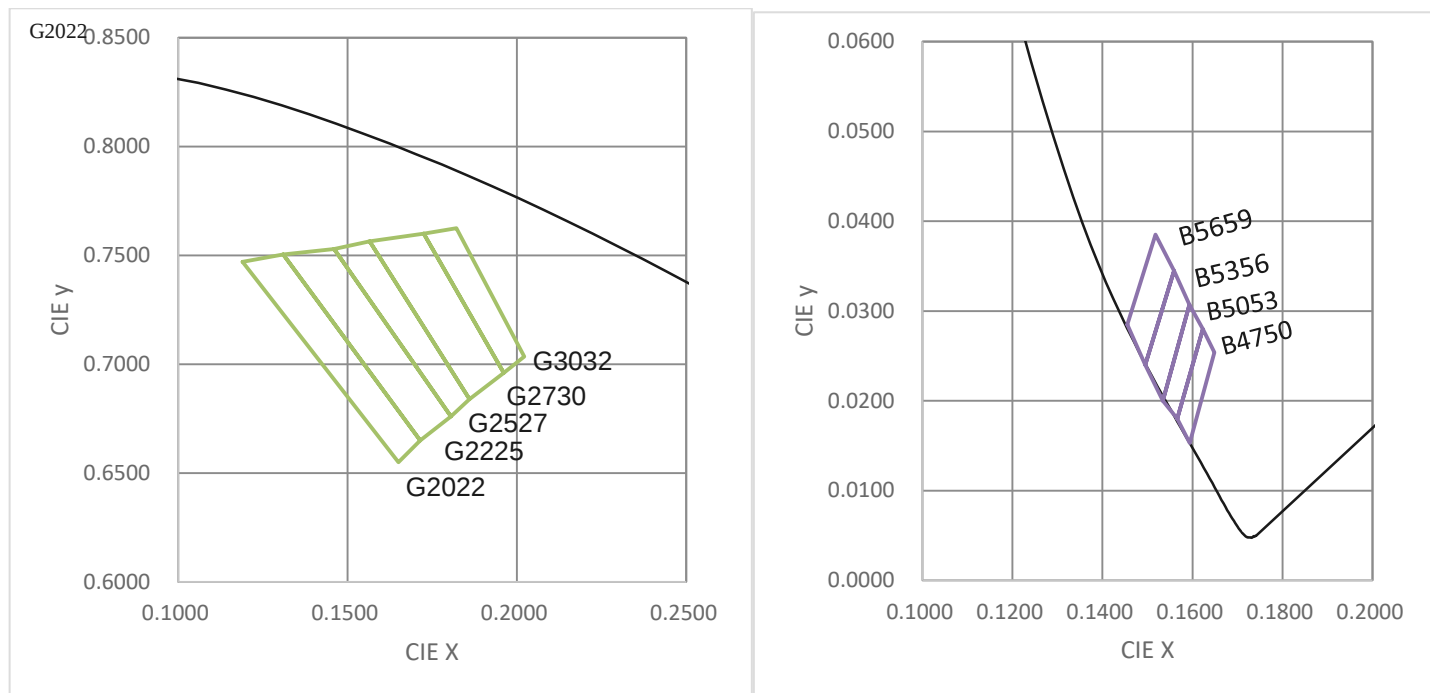
1. Luminous flux measurement tolerance: $\pm 8\%$.
2. Highlighted Black Box is possible output bins.

Wavelength Groups

Group Bin	Minimum Dominant Wavelength [nm]	Maximum Dominant Wavelength [nm]
R2024	620	624
R2427	624	627
R2730	627	630
G2022	520	522.5
G2225	522.5	525
G2527	525	527.5
G2730	527.5	530
G3032	530	532.5
B4750	447	450
B5053	450	453
B5356	453	456
B5659	456	459

Color Bin Structure





Color Bin Coordinates

Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
R2024	0.6879	0.3086	R2427	0.6957	0.301	R2730	0.7005	0.2963
	0.6915	0.3085		0.699	0.301		0.7038	0.2962
	0.699	0.301		0.7038	0.2962		0.708	0.292
	0.6957	0.301		0.7005	0.2963		0.7051	0.292

Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
G2022	0.119	0.747	G2225	0.131	0.7505	G2527	0.146	0.753
	0.131	0.7505		0.146	0.753		0.1565	0.7565
	0.1715	0.665		0.1805	0.676		0.186	0.684
	0.165	0.655		0.1715	0.665		0.1805	0.676

Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
G2730	0.1565	0.7565	G3032	0.1725	0.76
	0.1725	0.76		0.1821	0.7625
	0.1961	0.696		0.2022	0.7035
	0.186	0.684		0.1961	0.696

Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
B4750	0.1455	0.0285	B5053	0.1495	0.024	B356	0.1534	0.02
	0.1518	0.0385		0.1559	0.0345		0.1593	0.0307
	0.1559	0.0345		0.1593	0.0307		0.1623	0.028
	0.1495	0.024		0.1534	0.02		0.1566	0.018

Bin Code	CIE_x	CIE_y
B5659	0.1566	0.018
	0.1623	0.028
	0.1649	0.0254
	0.1594	0.0153

Notes:

1. Dominant wavelength measurement tolerance: $\pm 1\text{nm}$.

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Forward Voltage Bins

Bin code	Min Forward Voltage [V]	Max Forward Voltage [V]
1012	1.00	1.25
1215	1.25	1.50
1517	1.50	1.75
1720	1.75	2.00
2022	2.00	2.25
2225	2.25	2.50
2527	2.50	2.75
2730	2.75	3.00
3032	3.00	3.25
3235	3.25	3.50
3537	3.50	3.75
3740	3.75	4.00
4042	4.00	4.25
4245	4.25	4.50
4547	4.50	4.75
4750	4.75	5.00
5052	5.00	5.25
5255	5.25	5.50
5557	5.50	5.75
5760	5.75	6.00
6062	6.00	6.25
6265	6.25	6.50
6567	6.50	6.75
6770	6.75	7.00

Notes:

1. Forward voltage measurement tolerance: $\pm 0.05V$.
2. Forward voltage bins are defined at $I_F = 20mA$ operation.

5. Part Number

67-63-RGB0200H-AM

Part number is designated with below details.

67-63 = Product family name.

RGB = Color ^[1]

020 = Test current [mA]

0 = Lead Frame Type (0=Ag ; 1=Au ; 2=MLP)

H = Brightness Level (H=High ; M=Medium ; L=Low)

AM = Automotive application

Note

[1] Color :

Symbol	Description
C	Cool White
N	Neutral White
W	Warm White
PA	Phosphor Converted Amber
PR	Phosphor Converted Red
UB	Blue
IB	Ice Blue
SB	Sky Blue
UP	Purple
UG	Green
UY	Yellow
UYG	Brilliant Yellow Green
UPG	Pale Green
UA	Amber
UR	Red
SR	Super Red
RGB	RGB-Color
PYG	Phosphor Converted Yellow Green

6. Ordering Information

67-63-RGB0200H-ABC-DE-AM

Part Number of the 67-63	Order Code
67-63-RGB0200H-AM	67-63-RGB0200H-ABC-DE-AM

Order code contains information with below details :

ABC = Please refer to the chart to the right [1]

DE = internal code

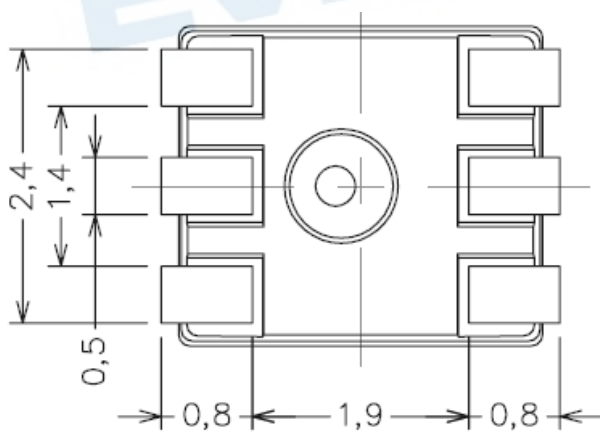
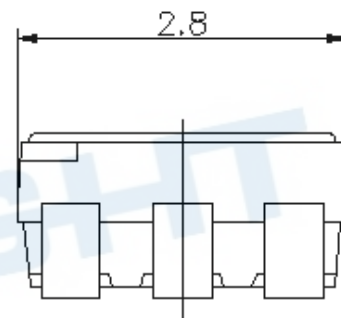
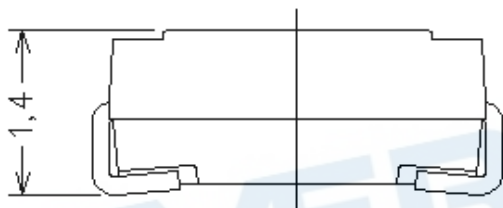
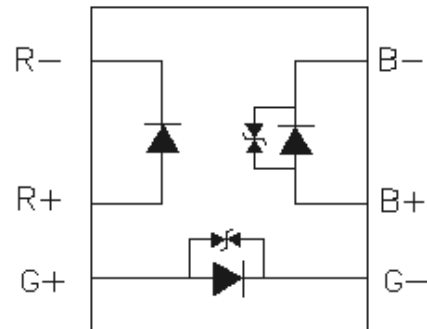
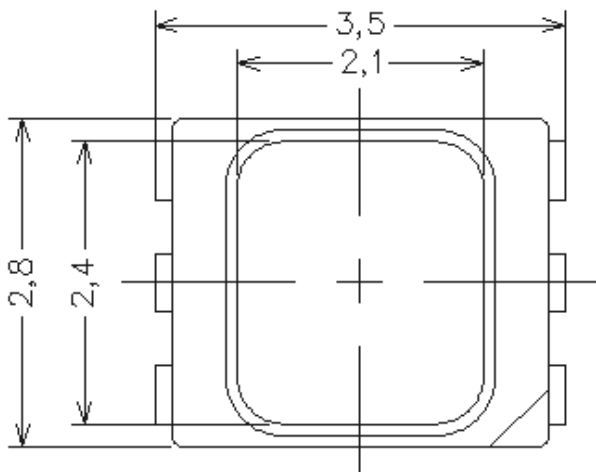
AM = Automotive Application

Note

[1] Group Bin chart

Group Bin	Dominant Wavelength (nm)		IV	VF
A04	Red	619-633	U2AA	1727
	Green	520-535	AABA	2537
	Blue	447-459	S2T2	2537

7. Mechanical Dimension

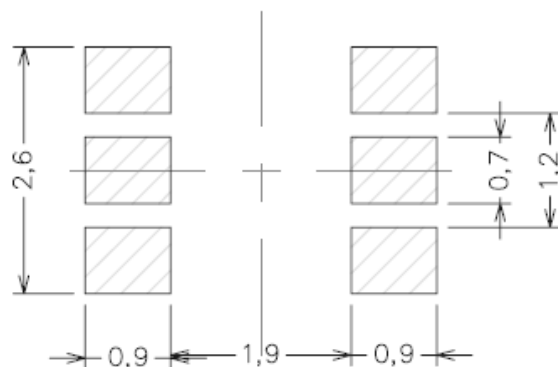


Bottom

Notes:

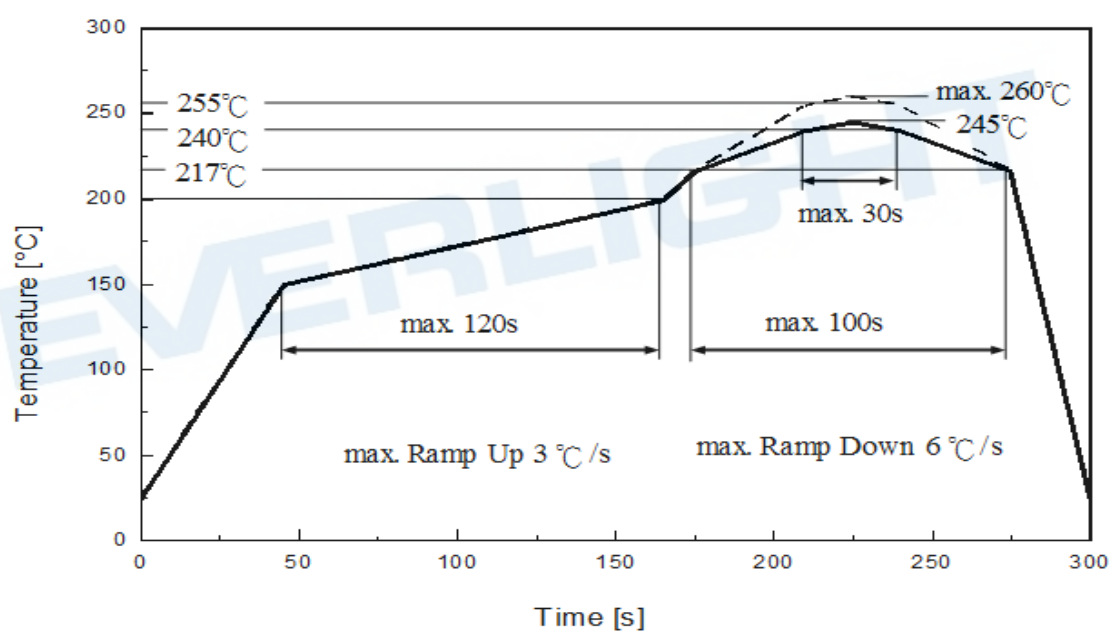
1. Dimensions are in millimeters.
2. Tolerances unless mentioned are $\pm 0.1\text{mm}$.

8. Recommended Soldering Pad



9. Reflow Soldering Profile

Soldering Condition (Reference: IPC/JEDEC J-STD-020D)



Profile Feature	Pb-Free Assembly	Unit
	Recommendation	
Ramp-up rate to preheat 25 °C to 150 °C	3	°C /sec
Time of soaking zone 150 °C to 200 °C	120	sec
Ramp-up rate to peak	3	°C /sec
Liquidus temperature	217	°C
Time above liquidus temperature	100	sec
Peak temperature (max.)	260	°C
Time within 5°C of the specified peak temperature	30	sec
Ramp-down Rate (max.)	6	°C /sec

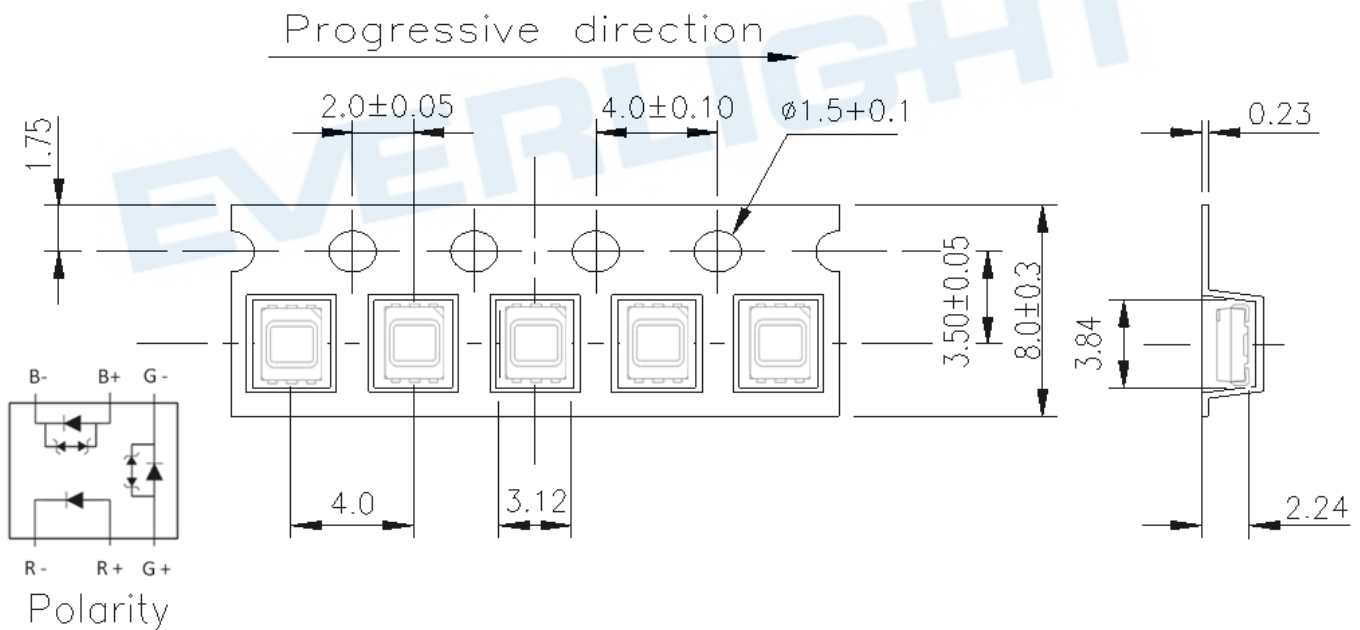
10. Packaging Information

• Product Labeling



- CPN : Customer's Product Number
- P/N : Everlight Part Number
- QTY : Packing Quantity
- CAT : Luminous Flux (Brightness) Bin
- HUE : Color Bin
- REF : Forward Voltage Bin
- LOT No : Lot Number

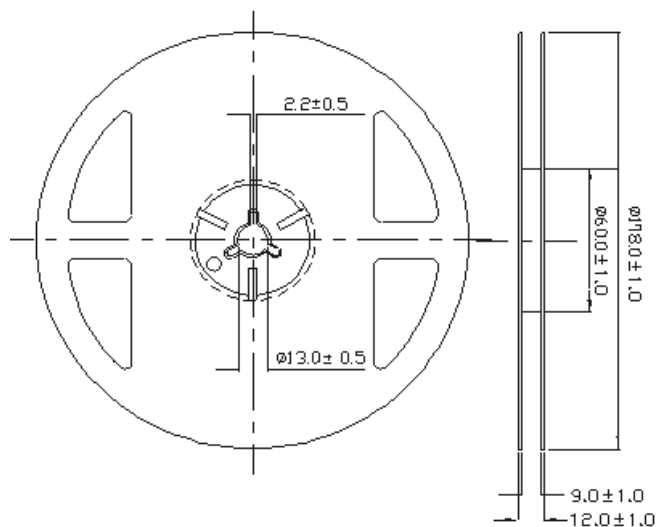
• Packing: Loaded Quantity 2000 pcs Per Reel



Notes:

1. Dimensions are in millimeters.

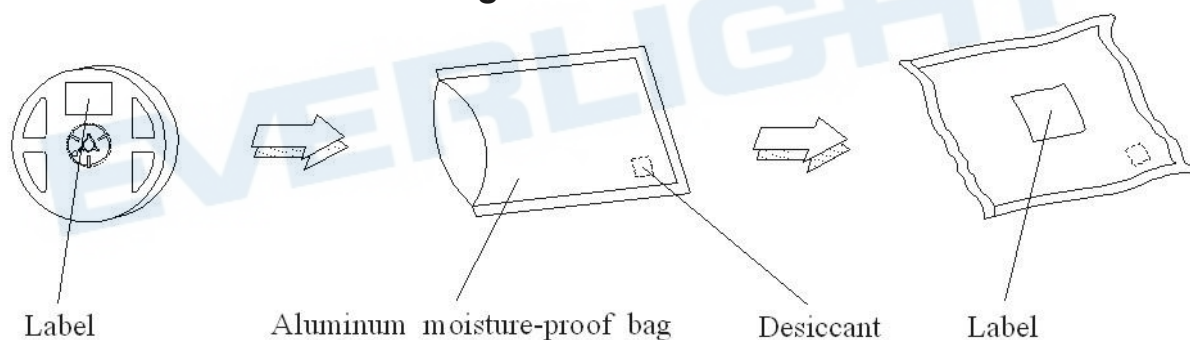
• Reel Dimensions



Notes:

1. Dimensions are in millimeters.

• Moisture Resistant Packing Process



11. Precaution for Use

1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (burn out will happen).

2. Assemblies

Do not stack assemblies containing LEDs to prevent damage to the optical surface of LEDs. Forces applied to the optical surface may result in the surface being damaged.

3. Soldering Condition

3.1 When soldering, do not put stress on the LEDs during heating.

3.2 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350℃ for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

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Revision History

Current Version : 13.Feb.2023

Issue No: DSE-0021499

Version: 7

Created by: Youngho Na

Rev.	Subjects (major change in previous version)	Modified date
1	Standard data sheet	2019/03/20
2	Revise Luminous Intensity max & Dominant Wavelength min	2019/03/28
3	Revise blue-chip Vf 2.75→2.5	2020/01/13
4	Revise green -chip Vf 2.75→2.5	2021/09/07
5	波段換成色塊 Bin (會議同意無其他地區需求，故切換)	2022/1/13
6	細分 RGB CIE 色塊(依客戶需求)	2022/2/25
7	According to customer request, Deleted Red letters	2023/02/13

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